



Pack Expo & the Internet of Things

Attend an informative presentation on the IoT at Pack Expo—and get a preview of our soon-to-be-released high-performance control solution: the Parker Automation Controller.

Coming to Pack Expo? Don't miss an informative presentation by our own Andy Balderson: "The Cloud, the Internet of Things and Your Data." Andy will discuss the three core architectures for accessing your plant floor and machine data remotely, and he'll take some of the mystery out of industry buzzwords like "IoT," "The Cloud" and "Industry 4.0." The presentation is focused on the packaging and industrial user base and will address the pros, cons and risks to be considered when connecting your machines and plants remotely.

When and Where: Monday, Nov. 3, 12:00 to 12:30 pm, Room N-4580 in the North Hall Grand Concourse.

And while you're at the event, be sure to stop by Booth #5739 for a preview of our latest innovation: the Parker Automation Controller (PAC). Designed for the global machine market, the powerful Parker Automation Controller combines machine logic, signal handling, advanced high-speed motion, and visualization into one performance-driven solution. With industry-leading EtherCAT communication for motion and I/O, and the Parker Automation Manager IDE for application development, the PAC gives OEMs an engineered solution for the most demanding applications.



Not coming to Pack Expo? Click [here](#) for more information on the Parker Automation Controller.

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